

Pch -12V -6A Middle Power MOSFET

Datasheet

| V _{DSS} | -12V |
|----------------------------|-------|
| R _{DS(on)} (Max.) | 19mΩ |
| I _D | ±6A |
| P _D | 1.25W |

Features

- 1) Low on resistance.
- 2) -1.5V Drive.
- 3) Built-in G-S Protection Diode.
- 4) Small Surface Mount Package (TSST8).
- 5) Pb-free lead plating ; RoHS compliant



Inner circuit



Packaging specifications

| | Packing | Embossed Tape |
|------|---------------------------|------------------|
| | Reel size (mm) | 180 |
| Туре | Tape width (mm) | 8 |
| | Basic ordering unit (pcs) | 3000 |
| | Taping code | TR |
| | Marking | SG |

Application

Switching

• Absolute maximum ratings $(T_a = 25^{\circ}C)$

| Parameter | Symbol | Value | Unit |
|------------------------------|-------------------------|-------------|------|
| Drain - Source voltage | V _{DSS} | -12 | V |
| Continuous drain current | I _D | ±6 | A |
| Pulsed drain current | I _{D,pulse} *1 | ±18 | A |
| Gate - Source voltage | V _{GSS} | 0~-8 | V |
| Dower disainstion | P _D *2 | 1.25 | W |
| Power dissipation | P _D *3 | 0.6 | W |
| Junction temperature | Tj | 150 | °C |
| Range of storage temperature | T _{stg} | -55 to +150 | °C |

•Thermal resistance

| Deremeter | Symbol | Values | | | Unit |
|--|-----------------|--------|------|--------------|------|
| Parameter | | Min. | Тур. | Max <u>.</u> | Unit |
| Thermal registeres innetion employet | R_{thJA}^{*2} | - | - | 100 | °C/W |
| Thermal resistance, junction - ambient | R_{thJA}^{*3} | - | - | 208 | °C/W |

• Electrical characteristics (T_a = 25°C)

| Deremeter | Sumphal | Conditions | | Values | | | |
|--|---|---|------|--------|------|-------|--|
| Parameter | Symbol Conditions | | Min. | Тур. | Max. | Unit | |
| Drain - Source breakdown voltage | V _{(BR)DSS} | V _{GS} = 0V, I _D = -1mA | -12 | - | - | v | |
| Breakdown voltage temperature coefficient | $\frac{\Delta V_{(BR)DSS}}{\Delta T_j}$ | I _D = -1mA referenced to 25°C | - | -5.0 | - | mV/°C | |
| Zero gate voltage drain current | I _{DSS} | V _{DS} = -12V, V _{GS} = 0V | - | - | -10 | μA | |
| Gate - Source leakage current | GSS | V _{GS} = -8V, V _{DS} = 0V | - | - | -10 | μA | |
| Gate threshold voltage | $V_{GS(th)}$ | V _{DS} = -6V, I _D = -1mA | -0.3 | - | -1.0 | V | |
| Gate threshold voltage temperature coefficient | $\frac{\Delta V_{GS(th)}}{\Delta T_j}$ | I _D = -1mA referenced to 25°C | - | 2.7 | - | mV/°C | |
| | | V _{GS} = -4.5V, I _D = -6A | - | 14 | 19 | | |
| Static drain - source | D *4 | V _{GS} = -2.5V, I _D = -3A | - | 17 | 24 | | |
| on - state resistance | $R_{DS(on)}^{*4}$ | V _{GS} = -1.8V, I _D = -3A | - | 22 | 33 | mΩ | |
| | | V _{GS} = -1.5V, I _D = -1.2A | - | 27 | 54 | | |
| Gate input resistance | R_{G} | f = 1MHz, open drain | - | 8 | - | Ω | |
| Forward Transfer Admittance | Y _{fs} ^{*4} | V _{DS} = -6V, I _D = -6A | 9 | - | - | S | |

*1 $Pw{\leq}10\mu s$, Duty cycle ${\leq}1\%$

- *2 Mounted on a ceramic board (30x30x0.8mm)
- *3 Mounted on a FR4 (20x20x0.8mm)
- *4 Pulsed





• Electrical characteristics ($T_a = 25^{\circ}C$)

| Deremeter | Cumphol | Conditions | | Linit | | | |
|------------------------------|-----------------------|---|------|-------|------|------|--|
| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Unit | |
| Input capacitance | C _{iss} | V _{GS} = 0V | - | 7800 | - | | |
| Output capacitance | C _{oss} | V _{DS} = -6V | - | 900 | - | pF | |
| Reverse transfer capacitance | C _{rss} | f = 1MHz | - | 850 | I | | |
| Turn - on delay time | t _{d(on)} *⁴ | V _{DD} ≃ -6V,V _{GS} = -4.5V | - | 25 | I | | |
| Rise time | t _r *4 | I _D = -3A | - | 100 | - | | |
| Turn - off delay time | $t_{d(off)}$ *4 | $R_L \simeq 2\Omega$ | _ | 580 | - | ns | |
| Fall time | t _f *4 | R _G = 10Ω | - | 260 | - | | |

• Gate charge characteristics ($T_a = 25^{\circ}C$)

| Deremeter | Sumbol | Symbol Conditions | | Values | | |
|----------------------|--------------------|--|---|--------|------|------|
| Parameter | Symbol | | | Тур. | Max. | Unit |
| Total gate charge | Q _g *4 | V _{DD} ≃ -6V, | - | 80 | - | |
| Gate - Source charge | Q _{gs} *4 | I _D = -6A, V _{GS} = -4.5V | - | 12 | - | nC |
| Gate - Drain charge | Q _{gd} *4 | V _{GS} = -4.5V | - | 13 | - | |

•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

| Parameter | Symbol | Symbol Conditions - | | Values | | |
|---------------------------------------|---------------------------|--|------|--------|------|------|
| | Symbol | Conditions | Min. | Тур. | Max. | Unit |
| Body diode continuous forward current | I _S | T - 25°0 | - | - | -1 | А |
| Body diode pulse current | I _{SP} *1 | $T_a = 25^{\circ}C$ | | - | -18 | А |
| Forward voltage | V _{SD} *4 | V _{GS} = 0V, I _S = -6A | - | - | -1.2 | V |





Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area



Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

Fig.4 Single Pulse Maximum Power dissipation









Fig.5 Typical Output Characteristics(I)

Fig.6 Typical Output Characteristics(II)



Fig.7 Breakdown Voltage vs. Junction Temperature



Fig.8 Typical Transfer Characteristics







Fig.9 Gate Threshold Voltage vs. Junction Temperature

Fig.11 Drain Current Derating Curve





Fig.10 Forward Transfer Admittance vs. Drain Current



Fig.14 Static Drain - Source On - State

• Electrical characteristic curves



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Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II)

Fig.17 Static Drain - Source On - State

Resistance vs. Drain Current (IV)

Fig.18 Static Drain - Source On - State Resistance vs. Drain Current (V)

Fig.16 Static Drain - Source On - State







Fig.19 Typical Capacitance vs.

Fig.20 Switching Characteristics



Fig.21 Dynamic Input Characteristics



Fig.22 Source Current vs. Source Drain Voltage





Measurement circuits

Fig. 1-1 SWITCHING TIME MEASUREMENT CIRCUIT



Fig. 2-1 GATE CHARGE MEASUREMENT CIRCUIT



Fig. 1-2 SWITCHING WAVEFORMS



Fig. 2-2 GATE CHARGE WAVEFORM





Dimensions

TSST8



Pattern of terminal position areas [Not a pattern of soldering pads]

| DIM | MILIMETERS | | INC | HES |
|-----|------------|------|-------|-------|
| | MIN | MAX | MIN | MAX |
| Α | 0.75 | 0.85 | 0.030 | 0.033 |
| A1 | 0.00 | 0.05 | 0.000 | 0.002 |
| b | 0.22 | 0.42 | 0.009 | 0.017 |
| С | 0.12 | 0.22 | 0.005 | 0.009 |
| D | 2.90 | 3.10 | 0.114 | 0.122 |
| E | 1.50 | 1.70 | 0.059 | 0.067 |
| е | 0.0 | 65 | 0.0 | 26 |
| HE | 1.80 | 2.00 | 0.071 | 0.079 |
| L | 0.05 | 0.25 | 0.002 | 0.010 |
| L1 | 0.05 | 0.25 | 0.002 | 0.010 |
| Lp | 0.15 | 0.34 | 0.006 | 0.013 |
| Lp1 | 0.15 | 0.34 | 0.006 | 0.013 |
| x | - | 0.10 | - | 0.004 |
| У | | 0.10 | - | 0.004 |

| DIM | | MILIMETERS | | HES |
|-----|-----|------------|-----|-------|
| DIN | MIN | MAX | MIN | MAX |
| b2 | - | 0.52 | - | 0.020 |
| e1 | 1. | 1.46 | | 057 |
| 11 | - | 0.44 | - | 0.017 |
| 12 | | 0.44 | - | 0.017 |

Dimension in mm/inches







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ROHM Customer Support System

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RT1A060AP - Web Page

Distribution Inventory

| Part Number | RT1A060AP |
|-----------------------------|-----------|
| Package | TSST8 |
| Unit Quantity | 3000 |
| Minimum Package Quantity | 3000 |
| Packing Type | Taping |
| Constitution Materials List | inquiry |
| RoHS | Yes |